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- Inputs Are TTL-Voltage Compatible
- Schmitt-Trigger Circuitry On A, B, and CLR Inputs for Slow Input Transition Rates
- **Edge Triggered From Active-High or Active-Low Gated Logic Inputs**
- Retriggerable for Very Long Output Pulses
- **Overriding Clear Terminates Output Pulse**
- Latch-Up Performance Exceeds 100 mA Per JESD 78, Class II
- **ESD Protection Exceeds JESD 22** 
  - 2000-V Human-Body Model (A114-A)
  - 200-V Machine Model (A115-A)
  - 1000-V Charged-Device Model (C101)

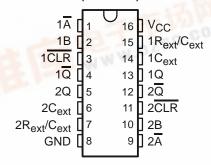
## description/ordering information

RODUCTION DATA information is current as of publication date roducts conform to specifications per the terms of Texas Instruments tandard warranty. Production processing does not necessarily include esting of all parameters.

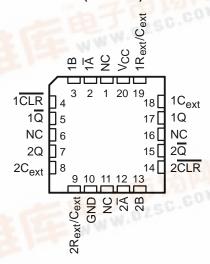
These edge-triggered multivibrators feature output pulse-duration control by three methods. In the first method, the  $\overline{A}$  input is low, and the B input goes high. In the second method, the B input is high, and the  $\overline{A}$  input goes low. In the third method, the  $\overline{A}$  input is low, the B input is high, and the clear (CLR) input goes high.

The output pulse duration is programmed by selecting external resistance and capacitance values. The external timing capacitor must be connected between C<sub>ext</sub> and R<sub>ext</sub>/C<sub>ext</sub> (positive) and an external resistor connected between R<sub>ext</sub>/C<sub>ext</sub> and V<sub>CC</sub>. To obtain variable pulse durations, connect an external variable resistance between Rext/Cext and Vcc. The output pulse duration also can be reduced by taking CLR low.

#### SN54AHCT123A . . . J OR W PACKAGE SN74AHCT123A . . . D, DB, DGV, N, OR PW PACKAGE (TOP VIEW)



#### SN54AHCT123A . . . FK PACKAGE (TOP VIEW)



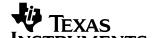
NC - No internal connection

#### ORDERING INFORMATION

TA	PACK	AGE†	ORDERABLE PART NUMBER	TOP-SIDE MARKING
	PDIP – N	Tube	SN74AHCT123AN	SN74AHCT123AN
	SOIC - D	Tube	SN74AHCT123AD	AHCT123A
–40°C to 85°C	3010 - D	Tape and reel	SN74AHCT123ADR	AHCTIZSA
	SSOP – DB	Tape and reel	SN74AHCT123ADBR	HB123A
	TSSOP – PW Tape and reel		SN74AHCT123APWR	HB123A
The state of	TVSOP - DGV	Tape and reel	SN74AHCT123ADGVR	HB123A
	CDIP – J	Tube	SNJ54AHCT123AJ	SNJ54AHCT123AJ
–55°C to 125°C	CFP – W	Tube	SNJ54AHCT123AW	SNJ54AHCT123AW
	LCCC – FK Tube		SNJ54AHCT123AFK	SNJ54AHCT123AFK

<sup>†</sup>Package drawings, standard packing quantities, thermal data, symbolization, and PCB design guidelines are available at www.ti.com/sc/package.

Please be aware that an important notice concerning availability, standard warranty, and use in critical applications of



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## description/ordering information(continued)

Pulse triggering occurs at a particular voltage level and is not directly related to the transition time of the input pulse. The  $\overline{A}$ , B, and  $\overline{CLR}$  inputs have Schmitt triggers with sufficient hysteresis to handle slow input transition rates with jitter-free triggering at the outputs.

Once triggered, the basic pulse duration can be extended by retriggering the gated low-level-active  $(\overline{A})$  or high-level-active (B) input. Pulse duration can be reduced by taking  $\overline{CLR}$  low.  $\overline{CLR}$  input can be used to override  $\overline{A}$  or B inputs. The input/output timing diagram illustrates pulse control by retriggering the inputs and early clearing.

The variance in output pulse duration from device to device typically is less than  $\pm 0.5\%$  for given external timing components. An example of this distribution for the 'AHCT123A is shown in Figure 10. Variations in output pulse duration versus supply voltage and temperature are shown in Figure 6.

During power up, Q outputs are in the low state, and  $\overline{Q}$  outputs are in the high state. The outputs are glitch free, without applying a reset pulse.

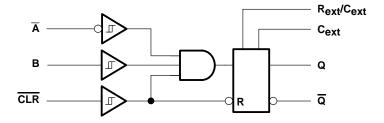
For additional application information on multivibrators, see the application report, *Designing With the SN74AHC123A and SN74AHCT123A*, literature number SCLA014.

## FUNCTION TABLE (each multivibrator)

I	NPUTS		OUTI	PUTS
CLR	Ā	В	Q	Q
L	Χ	Х	L	Н
Х	Н	X	∟†	H <sup>†</sup>
Х	Χ	L	L†	H <sup>†</sup>
Н	L	$\uparrow$	л	ъ
Н	$\downarrow$	Н	л	П
1	L	Н	Л	ъ

† These outputs are based on the assumption that the indicated steady-state conditions at the A and B inputs have been set up long enough to complete any pulse started before the setup.

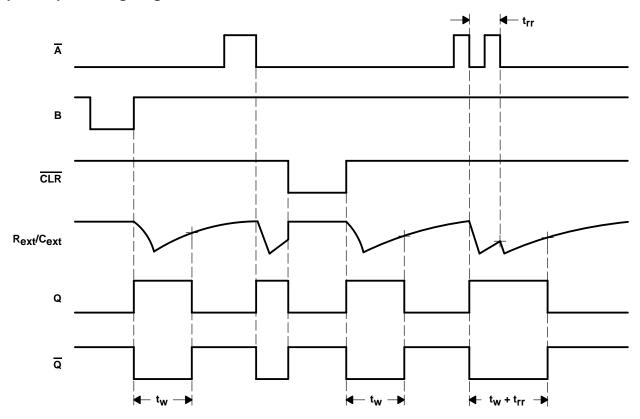
## logic diagram, each multivibrator (positive logic)





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## input/output timing diagram



## absolute maximum ratings over operating free-air temperature (unless otherwise noted)†

Supply voltage range, V <sub>CC</sub> (see Note 1)		–0.5 V to 7 V
Input voltage range, V <sub>I</sub> (see Note 2)		–0.5 V to 7 V
Output voltage range, VO (see Note 1)		0.5 V to V <sub>CC</sub> + 0.5 V
Input clamp current, $I_{IK}(V_I < 0)$		–20 mA
Output clamp current, I <sub>OK</sub> (V <sub>O</sub> < 0 or V <sub>O</sub> > V <sub>CO</sub>	C)	±20 mA
Continuous output current, $I_O(V_O = 0 \text{ to } V_{CC})$		±25 mA
Continuous current through V <sub>CC</sub> or GND		±50 mA
Package thermal impedance, θ <sub>JA</sub> (see Note 3):	: D package	73°C/W
	DB package	82°C/W
	DGV package	120°C/W
	N package	67°C/W
	PW package	108°C/W
Storage temperature range, T <sub>stg</sub>		–65°C to 150°C

<sup>†</sup> Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

- NOTES: 1. Voltage values are with respect to the network ground terminal.
  - 2. The input and output voltage ratings may be exceeded if the input and output current ratings are observed.
  - 3. The package thermal impedance is calculated in accordance with JESD 51-7.



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## recommended operating conditions (see Note 4)

		SN54AHCT123A		SN74AHC	UNIT	
		MIN	MAX	MIN	MAX	UNII
Vcc	Supply voltage	4.5	5.5	4.5	5.5	V
V <sub>IH</sub>	High-level input voltage	2		2		V
$V_{IL}$	Low-level input voltage		0.8		8.0	V
VI	Input voltage	0	5.5	0	5.5	V
Vo	Output voltage	0	Vcc	0	VCC	V
IOH	High-level output current		-8		-8	mA
loL	Low-level output current		8		8	mA
R <sub>ext</sub>	External timing resistance	1k		1k		Ω
Δt/ΔV <sub>CC</sub>	Power-up ramp rate	1		1		ms/V
TA	Operating free-air temperature	<b>-</b> 55	125	-40	85	°C

NOTE 4: Unused R<sub>ext</sub>/C<sub>ext</sub> terminals should be left unconnected. All remaining unused inputs of the device must be held at V<sub>CC</sub> or GND to ensure proper device operation. Refer to the TI application report, *Implications of Slow or Floating CMOS Inputs*, literature number SCBA004.

# electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER		TEST CONDITIONS	V	T,	<sub>Δ</sub> = 25°(	3	SN54AH0	CT123A	SN74AHC	T123A	UNIT
FA	KANETER	TEST CONDITIONS	vcc	MIN	TYP	MAX	MIN	MAX	MIN	MAX	UNIT
\/a		I <sub>OH</sub> = -50 μA	4.5 V	4.4	4.5		4.4		4.4		V
VOH		$I_{OH} = -8 \text{ mA}$	4.5 V	3.94			3.8		3.8		V
V/01		I <sub>OL</sub> = 50 μA	4.5 V			0.1		0.1		0.1	V
VOL		I <sub>OL</sub> = 8 mA	4.5 V			0.36		0.5		0.44	V
	R <sub>ext</sub> /C <sub>ext</sub> †	$V_I = V_{CC}$ or GND	5.5 V			±0.25		±2.5		±2.5	
Ιį	Ā, B, and CLR	V <sub>I</sub> = V <sub>CC</sub> or GND	0 V to 5.5 V			±0.1		±1*		±1	μΑ
Icc	Quiescent	$V_I = V_{CC}$ or GND, $I_O = 0$	5.5 V			4		40		40	μΑ
Icc	Active state (per circuit)	$V_I = V_{CC}$ or GND, $R_{ext}/C_{ext} = 0.5 V_{CC}$	5.5 V		560	750		975		975	μΑ
Δlcc	‡	One input at 3.4 V, Other inputs at V <sub>CC</sub> or GND	5.5 V			1.35		1.5		1.5	mA
Ci		$V_I = V_{CC}$ or GND	5 V		1.9	10				10	pF

 $<sup>^{*}</sup>$  On products compliant to MIL-PRF-38535, this parameter is not production tested at  $V_{CC} = 0 \text{ V}$ .

# timing requirements over recommended operating free-air temperature range, $V_{CC}$ = 5 V $\pm$ 0.5 V (unless otherwise noted) (see Figure 1)

	TEST CONDITIONS		T,	T <sub>A</sub> = 25°C		SN54AHCT123A		SN74AHCT123A		UNIT	
		TEST CONDITIONS		MIN	TYP	MAX	MIN	MAX	MIN	MAX	UNIT
	Pulse	CLR		5			5		5		20
t <sub>W</sub>	duration	A or B trigger		5			5		5		ns
	. D		$R_{ext} = 1 k\Omega$ , $C_{ext} = 100 pF$	§	60		§		§		ns
t <sub>rr</sub> Pulse retrigger time		igger time	$R_{ext} = 1 \text{ k}\Omega, C_{ext} = 0.01 \mu\text{F}$	§	1.5		§		§		μs

<sup>§</sup> See retriggering data in the application information section.



<sup>&</sup>lt;sup>†</sup> This test is performed with the terminal in the off-state condition.

<sup>‡</sup>This is the increase in supply current for each input at one of the specified TTL voltage levels rather than 0 V or V<sub>CC</sub>.

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# switching characteristics over recommended operating free-air temperature range, $V_{CC}$ = 5 V $\pm$ 0.5 V (unless otherwise noted) (see Figure 1)

	FROM	то	TEST	T	λ = 25°C	;	SN54AHC	T123A	SN74AHC	T123A	
PARAMETER	(INPUT)	(OUTPUT)	CONDITIONS	MIN	TYP	MAX	MIN	MAX	MIN	MAX	UNIT
<sup>t</sup> PLH	A or B		C: 45 pF		5.3*	10*	1*	13*	1	11	ns
<sup>t</sup> PHL	A or B	Q or Q	C <sub>L</sub> = 15 pF		5.3*	10*	1*	13*	1	11	ns
t <sub>PLH</sub>	<del></del>	0	C 15 pE		7.7*	12*	1*	15*	1	13	20
t <sub>PHL</sub>	CLR	Q or Q	C <sub>L</sub> = 15 pF		7.7*	12*	1*	15*	1	13	ns
t <sub>PLH</sub>	<u> </u>	0	C: - 15 pE		8*	13*	1*	16*	1	14	ns
t <sub>PHL</sub>	CLR trigger	Q or Q	C <sub>L</sub> = 15 pF		8*	13*	1*	16*	1	14	115
<sup>t</sup> PLH		0	C <sub>1</sub> = 50 pF		6.8	11	1	14	1	12	ns
<sup>t</sup> PHL	A or B	Q or Q	OL = 30 pr		6.8	11	1	14	1	12	115
<sup>t</sup> PLH	0.0	Q or Q	C 50 pE		9.2	13	1	16	1	14	ns
<sup>t</sup> PHL	CLR	Q or Q	C <sub>L</sub> = 50 pF		9.2	13	1	16	1	14	115
<sup>t</sup> PLH	CLR trigger	Q or Q	$\overline{Q}$ $C_L = 50 pF$		9.5	14	1	17	1	15	ns
<sup>t</sup> PHL	CLR ingger	QorQ			9.5	14	1	17	1	15	115
			$C_L = 50 \text{ pF},$ $C_{ext} = 28 \text{ pF},$ $R_{ext} = 2 \text{ k}\Omega$		133	200		240		240	ns
t <sub>w</sub> †		Q or $\overline{Q}$	$C_L$ = 50 pF, $C_{ext}$ = 0.01 $\mu$ F, $R_{ext}$ = 10 k $\Omega$	90	100	110	90	110	90	110	μs
			$C_L$ = 50 pF, $C_{ext}$ = 0.1 $\mu$ F, $R_{ext}$ = 10 k $\Omega$	0.9	1	1.1	0.9	1.1	0.9	1.1	ms
∆t <sub>W</sub> ‡					±1						%

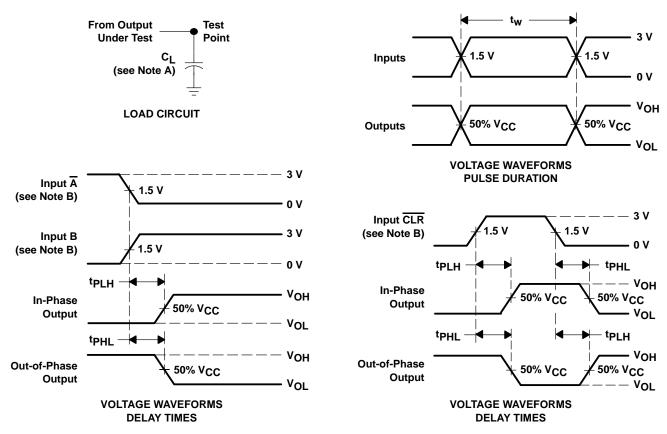
## operating characteristics, $V_{CC} = 5 \text{ V}$ , $T_A = 25^{\circ}\text{C}$

PARAMETER	TEST CONDITIONS	TYP	UNIT
C <sub>pd</sub> Power dissipation capacitance	No load	29	pF

<sup>\*</sup> On products compliant to MIL-PRF-38535, this parameter is not production tested. †  $t_W$  = Pulse duration at Q and  $\overline{Q}$  outputs ‡  $\Delta t_W$  = Output pulse-duration variation (Q and  $\overline{Q}$ ) between circuits in same package

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#### PARAMETER MEASUREMENT INFORMATION



NOTES: A. C<sub>L</sub> includes probe and jig capacitance.

- B. All input pulses are supplied by generators having the following characteristics:  $Z_0 = 50 \Omega$ ,  $t_f = 3 \text{ ns}$ ,  $t_f = 3 \text{ ns}$ .
- C. The outputs are measured one at a time with one input transition per measurement.

Figure 1. Load Circuit and Voltage Waveforms

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#### APPLICATION INFORMATION

#### caution in use

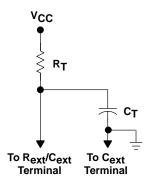
To prevent malfunctions due to noise, connect a high-frequency capacitor between  $V_{CC}$  and GND, and keep the wiring between the external components and  $C_{ext}$  and  $R_{ext}/C_{ext}$  terminals as short as possible.

## power-down considerations

Large values of  $C_{ext}$  may cause problems when powering down the 'AHCT123A devices because of the amount of energy stored in the capacitor. When a system containing this device is powered down, the capacitor may discharge from  $V_{CC}$  through the protection diodes at pin 2 or pin 14. Current through the input protection diodes must be limited to 30 mA; therefore, the turn-off time of the  $V_{CC}$  power supply must not be faster than  $t = V_{CC} \times C_{ext}/30$  mA. For example, if  $V_{CC} = 5$  V and  $V_{CC} = 15$  PF, the  $V_{CC}$  supply must turn off no faster than  $v_{CC} = 15$  V and  $v_{CC} = 15$  V and  $v_{CC} = 15$  PF, the  $v_{CC} = 15$  PF, the v

#### output pulse duration

The output pulse duration,  $t_W$ , is determined primarily by the values of the external capacitance ( $C_T$ ) and timing resistance ( $R_T$ ). The timing components are connected as shown in Figure 2.



**Figure 2. Timing-Component Connections** 

The pulse duration is given by:

$$t_w = K \times R_T \times C_T$$
 (1) if  $C_T$  is  $\geq 1000$  pF,  $K = 1.0$  or if  $C_T$  is  $< 1000$  pF,  $K$  can be determined from Figure 5

where:

tw = pulse duration in ns

 $R_T$  = external timing resistance in  $k\Omega$ 

C<sub>T</sub> = external capacitance in pF

K = multiplier factor

Equation 1 and Figure 3 can be used to determine values for pulse duration, external resistance, and external capacitance.



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#### **APPLICATION INFORMATION**

## retriggering data

The minimum input retriggering time ( $t_{MIR}$ ) is the minimum time required after the initial signal before retriggering the input. After  $t_{MIR}$ , the device retriggers the output. Experimentally, it also can be shown that to retrigger the output pulse, the two adjacent input signals should be  $t_{MIR}$  apart, where  $t_{MIR} = 0.30 \times t_{w}$ . The retrigger pulse duration is calculated as shown in Figure 3.

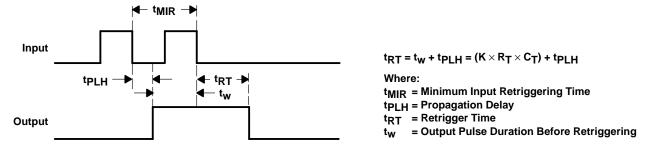
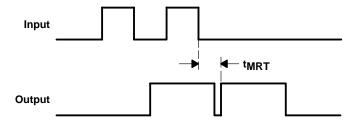


Figure 3. Retrigger Pulse Duration

The minimum value from the end of the input pulse to the beginning of the retriggered output should be approximately 15 ns to ensure a retriggered output (see Figure 4).



 $t_{MRT}$ = Minimum Time Between the End of the Second Input Pulse and the Beginning of the Retriggered Output  $t_{MRT}$ = 15 ns

Figure 4. Input/Output Requirements



#### APPLICATION INFORMATION<sup>†</sup>

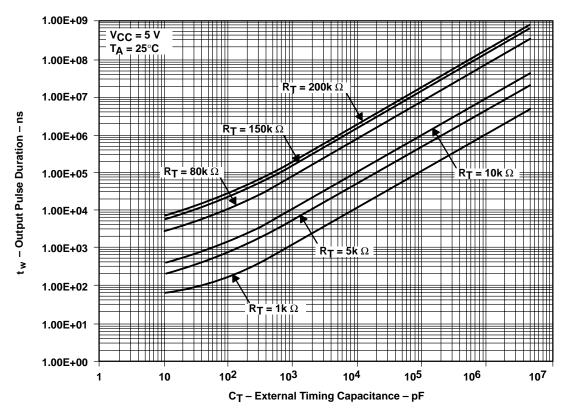


Figure 5. Output Pulse Duration vs External Timing Capacitance

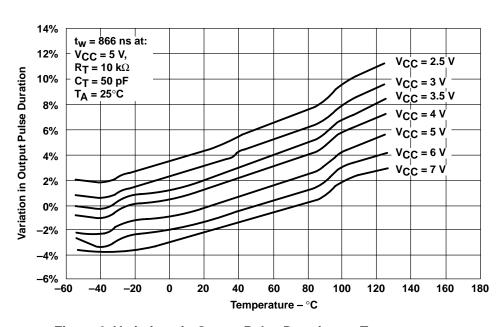


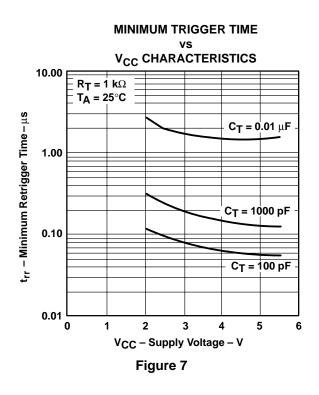
Figure 6. Variations in Output Pulse Duration vs Temperature

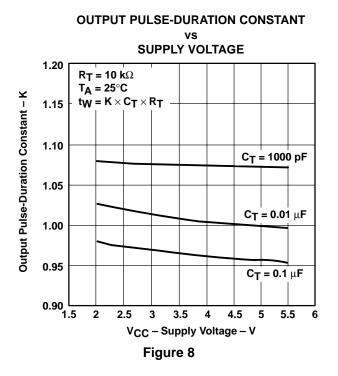
<sup>†</sup>Operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied.

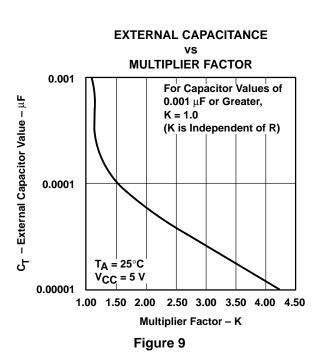


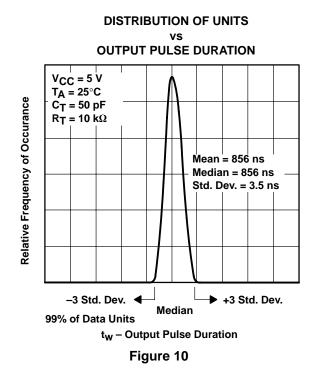
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#### APPLICATION INFORMATION<sup>†</sup>









<sup>†</sup>Operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied.







26-Sep-2005

## **PACKAGING INFORMATION**

Orderable Device	Status <sup>(1)</sup>	Package Type	Package Drawing	Pins	Package Qty	e Eco Plan <sup>(2)</sup>	Lead/Ball Finish	MSL Peak Temp <sup>(3)</sup>
5962-9861601Q2A	ACTIVE	LCCC	FK	20	1	TBD	Call TI	Level-NC-NC-NC
5962-9861601QEA	ACTIVE	CDIP	J	16	1	TBD	Call TI	Level-NC-NC-NC
5962-9861601QFA	ACTIVE	CFP	W	16	1	TBD	Call TI	Level-NC-NC-NC
74AHCT123ADGVRE4	ACTIVE	TVSOP	DGV	16	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74AHCT123AD	ACTIVE	SOIC	D	16	40	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74AHCT123ADBR	ACTIVE	SSOP	DB	16	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74AHCT123ADBRE4	ACTIVE	SSOP	DB	16	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74AHCT123ADE4	ACTIVE	SOIC	D	16	40	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74AHCT123ADGVR	ACTIVE	TVSOP	DGV	16	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74AHCT123ADR	ACTIVE	SOIC	D	16	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74AHCT123ADRE4	ACTIVE	SOIC	D	16	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74AHCT123AN	ACTIVE	PDIP	N	16	25	Pb-Free (RoHS)	CU NIPDAU	Level-NC-NC-NC
SN74AHCT123ANE4	ACTIVE	PDIP	N	16	25	Pb-Free (RoHS)	CU NIPDAU	Level-NC-NC-NC
SN74AHCT123APWR	ACTIVE	TSSOP	PW	16	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74AHCT123APWRE4	ACTIVE	TSSOP	PW	16	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SNJ54AHCT123AFK	ACTIVE	LCCC	FK	20	1	TBD	Call TI	Level-NC-NC-NC
SNJ54AHCT123AJ	ACTIVE	CDIP	J	16	1	TBD	Call TI	Level-NC-NC-NC
SNJ54AHCT123AW	ACTIVE	CFP	W	16	1	TBD	Call TI	Level-NC-NC-NC

<sup>(1)</sup> The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

**NRND:** Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

**OBSOLETE:** TI has discontinued the production of the device.

(2) Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS) or Green (RoHS & no Sb/Br) - please check http://www.ti.com/productcontent for the latest availability information and additional product content details.

TBD: The Pb-Free/Green conversion plan has not been defined.

**Pb-Free** (RoHS): TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.

Green (RoHS & no Sb/Br): TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

<sup>(3)</sup> MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.



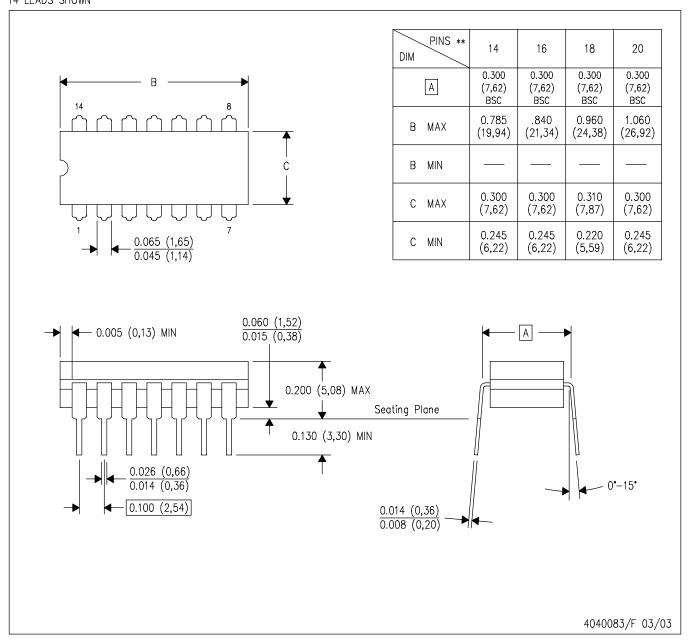
## PACKAGE OPTION ADDENDUM

26-Sep-2005

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## 14 LEADS SHOWN

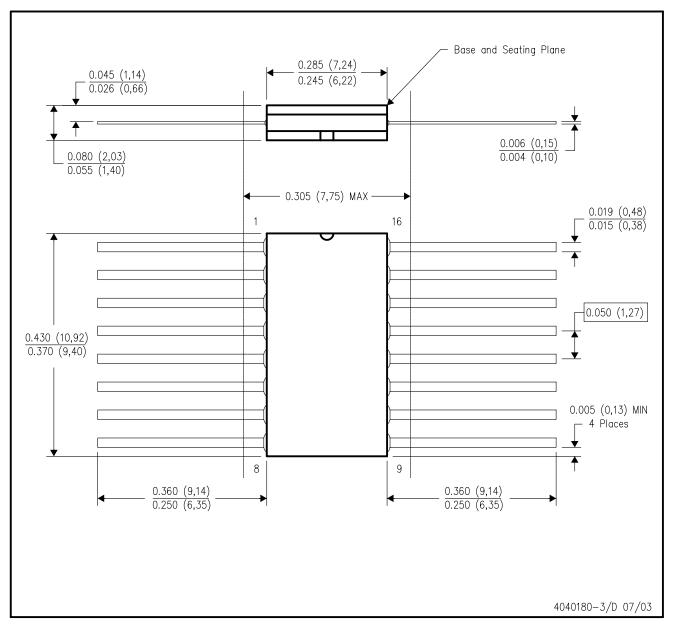


NOTES:

- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- C. This package is hermetically sealed with a ceramic lid using glass frit.
- D. Index point is provided on cap for terminal identification only on press ceramic glass frit seal only.
- E. Falls within MIL STD 1835 GDIP1-T14, GDIP1-T16, GDIP1-T18 and GDIP1-T20.

## W (R-GDFP-F16)

## CERAMIC DUAL FLATPACK



NOTES:

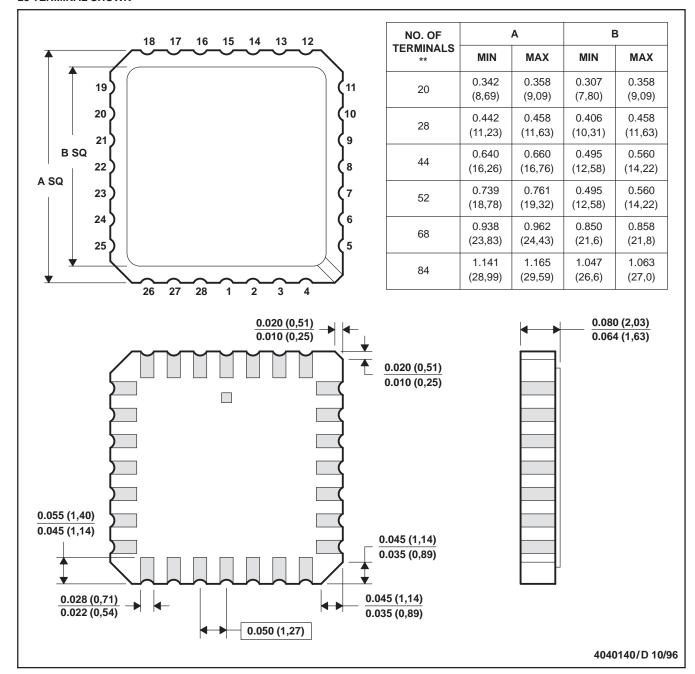
- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- C. This package can be hermetically sealed with a ceramic lid using glass frit.
- D. Index point is provided on cap for terminal identification only.
- E. Falls within MIL STD 1835 GDFP1-F16 and JEDEC MO-092AC



## FK (S-CQCC-N\*\*)

#### **28 TERMINAL SHOWN**

## **LEADLESS CERAMIC CHIP CARRIER**



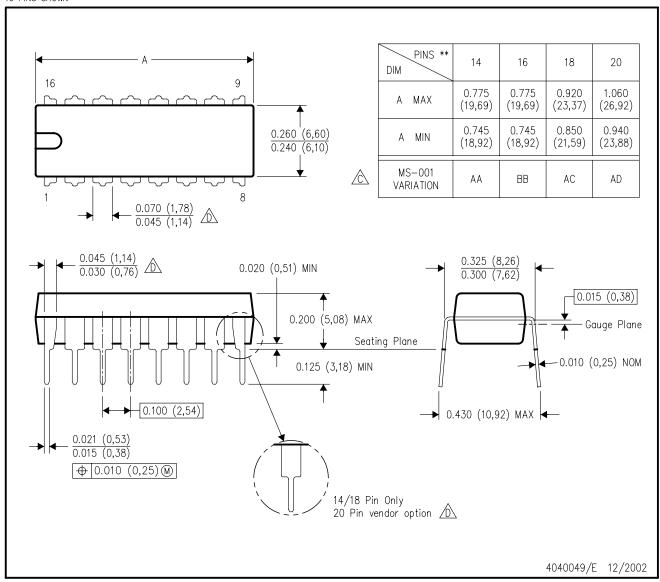
- NOTES: A. All linear dimensions are in inches (millimeters).
  - B. This drawing is subject to change without notice.
  - C. This package can be hermetically sealed with a metal lid.
  - D. The terminals are gold plated.
  - E. Falls within JEDEC MS-004



## N (R-PDIP-T\*\*)

## PLASTIC DUAL-IN-LINE PACKAGE

16 PINS SHOWN



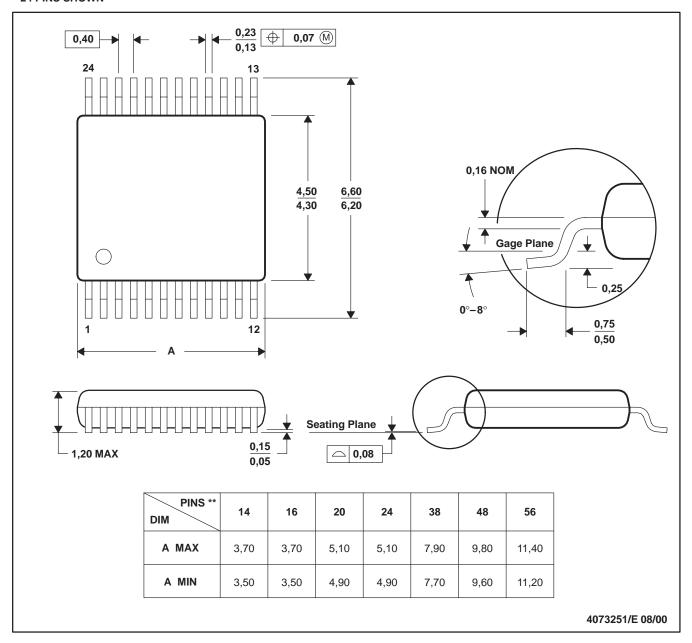
NOTES:

- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- Falls within JEDEC MS-001, except 18 and 20 pin minimum body length (Dim A).
- The 20 pin end lead shoulder width is a vendor option, either half or full width.

## DGV (R-PDSO-G\*\*)

## **24 PINS SHOWN**

## **PLASTIC SMALL-OUTLINE**



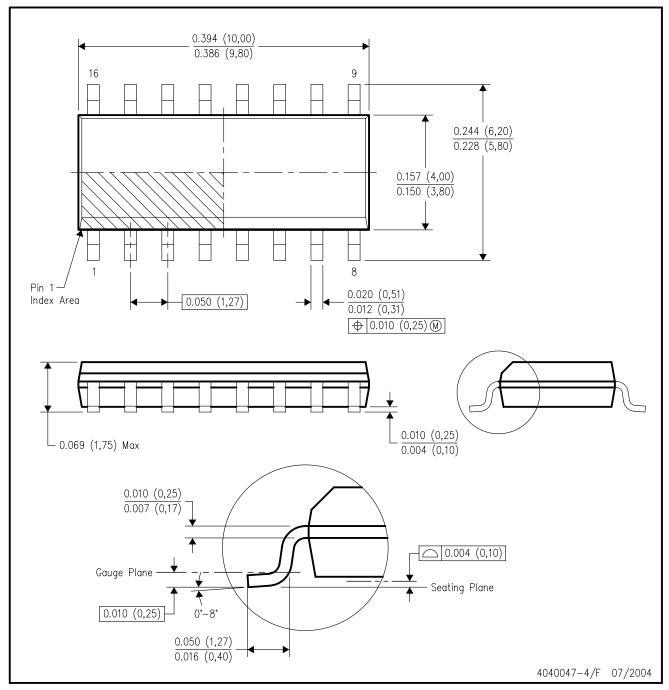
NOTES: A. All linear dimensions are in millimeters.

- B. This drawing is subject to change without notice.
- C. Body dimensions do not include mold flash or protrusion, not to exceed 0,15 per side.
- D. Falls within JEDEC: 24/48 Pins MO-153 14/16/20/56 Pins – MO-194



## D (R-PDSO-G16)

## PLASTIC SMALL-OUTLINE PACKAGE



NOTES:

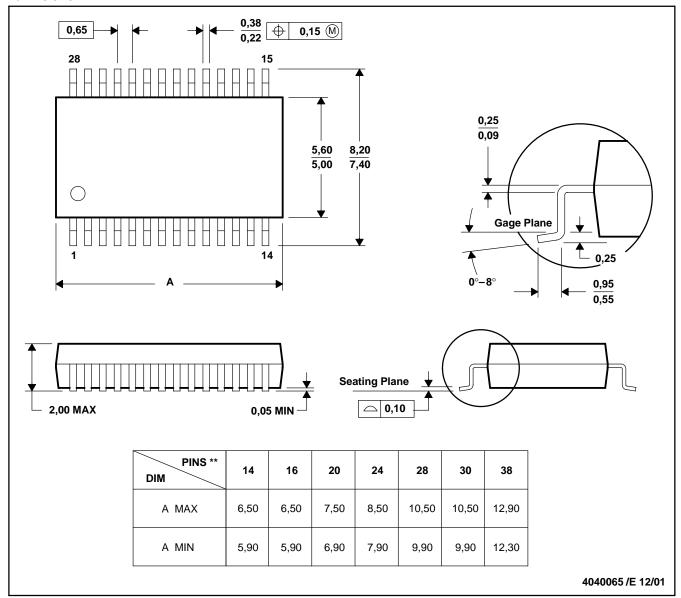
- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- C. Body dimensions do not include mold flash or protrusion not to exceed 0.006 (0,15).
- D. Falls within JEDEC MS-012 variation AC.



## DB (R-PDSO-G\*\*)

## **PLASTIC SMALL-OUTLINE**

## **28 PINS SHOWN**



NOTES: A. All linear dimensions are in millimeters.

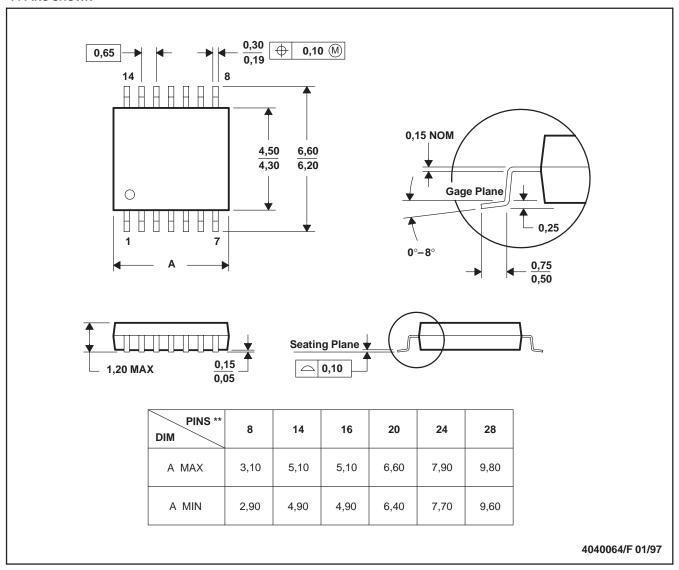
- B. This drawing is subject to change without notice.
- C. Body dimensions do not include mold flash or protrusion not to exceed 0,15.
- D. Falls within JEDEC MO-150



## PW (R-PDSO-G\*\*)

## 14 PINS SHOWN

## PLASTIC SMALL-OUTLINE PACKAGE



NOTES: A. All linear dimensions are in millimeters.

- B. This drawing is subject to change without notice.
- C. Body dimensions do not include mold flash or protrusion not to exceed 0,15.
- D. Falls within JEDEC MO-153

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